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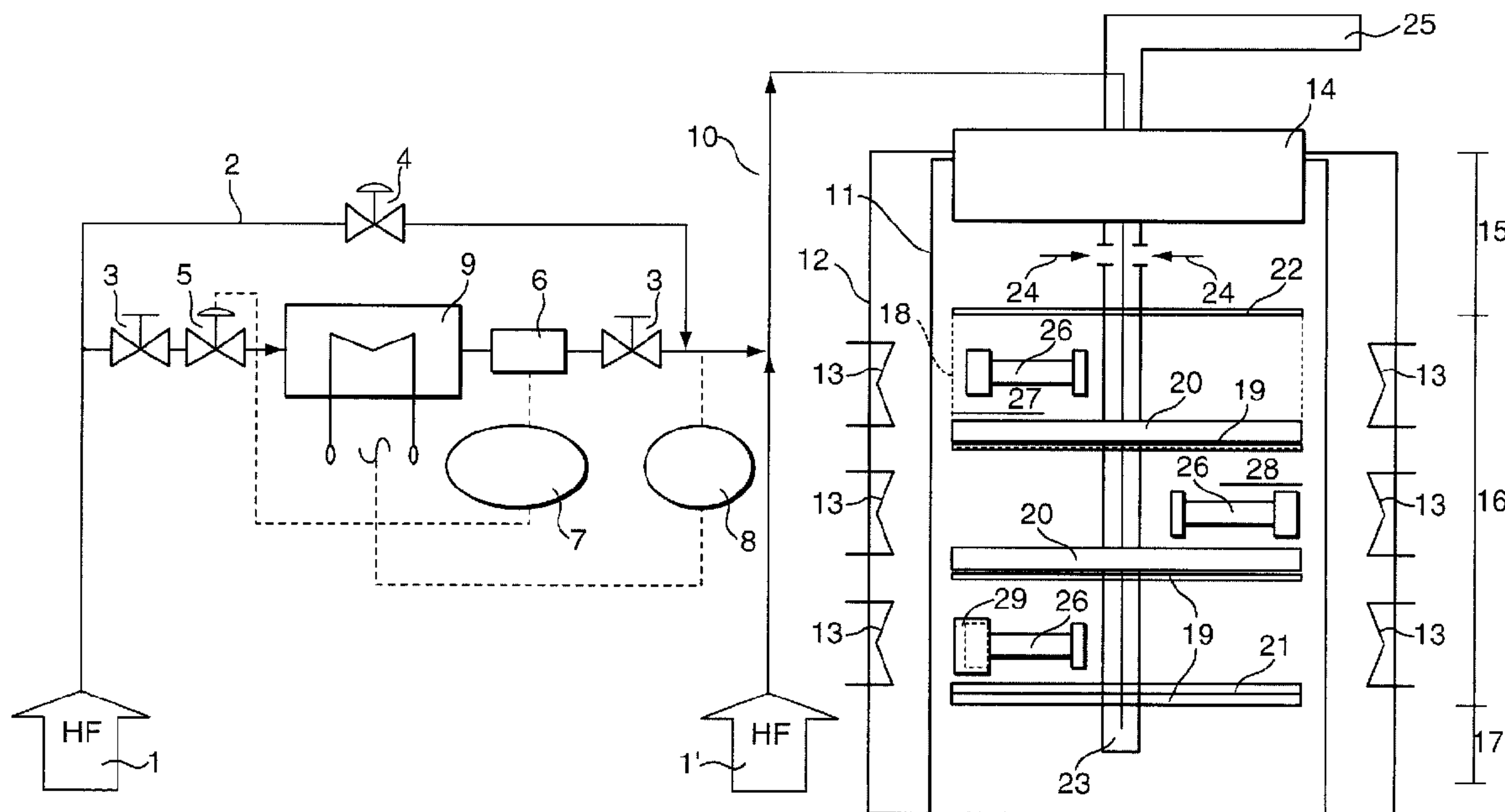
(54) Titre : DISPOSITIF DE NETTOYAGE DE COMPOSANTS OXYDES OU CORRODES EN PRESENCE D'UN MELANGE GAZEUX HALOGENE

(54) Title: DEVICE FOR CLEANING OXIDIZED OR CORRODED COMPONENTS IN THE PRESENCE OF A HALOGENOUS GAS MIXTURE



(57) Abrégé/Abstract:
A device for cleaning oxidized or corroded components (26) is described, especially gas turbine components which are exposed to hot gases, in the presence of a halogenous gas, with a cleaning retort which is designed in the shape of a boiler or cylinder and into which indirectly or directly leads a feed line which is connected via a flow control unit to a gas reservoir which stores the halogenous gas, and in which a device for gas distribution is integrated. The invention is characterized in that the flow control unit has a gas volume control valve (5), a heat exchanger unit (9) and also a gas volume measuring unit (6) in sequence along the throughflow direction of the halogenous gas which flows through the feed line. Furthermore, a gas distribution in the retort is described, which directs the halogenous gas directly to the components which are to be cleaned.

Abstract

A device for cleaning oxidized or corroded components (26) is described, especially gas turbine components which are exposed to hot gases, in the presence of a halogenous gas, with a cleaning retort which is designed in the shape of a boiler or cylinder and into which indirectly or directly leads a feed line which is connected via a flow control unit to a gas reservoir which stores the halogenous gas, and in which a device for gas distribution is integrated.

The invention is characterized in that the flow control unit has a gas volume control valve (5), a heat exchanger unit (9) and also a gas volume measuring unit (6) in sequence along the throughflow direction of the halogenous gas which flows through the feed line. Furthermore, a gas distribution in the retort is described, which directs the halogenous gas directly to the components which are to be cleaned.

(Fig. 1)

DEVICE FOR CLEANING OXIDIZED OR CORRODED COMPONENTS IN THE PRESENCE OF A HALOGENOUS GAS MIXTURE

Technical field

The invention refers to a device for cleaning oxidized or corroded components in the presence of a halogenous gas mixture, with a cleaning retort into which indirectly or directly leads a feed line which is connected via a flow control unit to a gas reservoir which stores the halogenous gas mixture. In particular, these components can be turbine components, especially gas turbine blades, which are exposed to impingement by hot gases.

Background of the invention

Turbine components for power plants or stationary gas turbine installations, which are indirectly or directly exposed to hot gas flows, such as stator blades or rotor blades, heat accumulating segments or similar components or component groups which delimit the hot gas passage, are subjected to operation-induced material degradations which frequently lead to cracks and to mechanical weakening of the respective components which is associated with them. On account of the high temperature stresses and pressure stresses which prevail in the hot gas passages, to which the corresponding components, which are mostly manufactured from nickel-based materials, are exposed, complex chemically and thermally stable oxides, as result of external and internal oxidation, are deposited on the surfaces of the components, as operating time increases, within the developing crack openings and also within the regions inside the base material which lie close to the surface.

With a special process chain, it is the aim to change the components which are stressed in this way and partly damaged into a condition which largely corresponds to the condition of a newly manufactured comparable component. In this case, it is one of the steps to carefully clean the component which is to be reworked, i.e. to remove the complex oxide layer which is deposited on the surface of the component, and also to remove cracks which have developed within it, without damaging the material of the component itself in the process.

A corresponding cleaning process for the previously referenced components is described in DE 28 10 598 A1, which components are exposed to a pressurized cleaning atmosphere at temperatures of above 1000^{0} C, in which gaseous active fluoride ions are contained. In the presence of such a cleaning atmosphere, the complex oxide reacts with the fluoride ions, forming a gaseous fluoride, without damaging the component material in the process. Such cleaning processes, which are also generally referred to as FIC (fluoride ion cleaning), are sufficiently well-known and described in many publications. In this connection, EP 0 209 307 B1 may be representatively referred to, from which a respectable overview of the cleaning technologies which are known up to now can be gathered.

The object of completely removing oxide layer portions which have been deposited especially in crack-induced fissure or fault structures is largely common to all efforts for improving such FIC processes, particularly as the smallest residual portions of oxidized or corroded surfaces already have long-term effects on subsequent repair measures. For purposes of crack-healing on the respectively cleaned components, a soldering or welding process is typically carried out in such a way that a repair alloy in powder form is

accumulated over a cleaned crack and in the presence of a vacuum and by heat action is made to melt and finally to flow into the fissure-like crack. In this case, a wetting of the crack wall with liquefied repair alloy is formed. It is obvious that corresponding wettings on a component surface which is not afflicted with an oxide layer are not carried out, or carried out to a far lesser extent, as a result of which repair weak spots ultimately result, which is necessary to avoid.

For improving the cleaning result, in the previously cited EP 0 209 307 B1 it is proposed to cyclically vary the pressure within the reactive cleaning atmosphere in order to create in this way a common movement of the reactive gaseous fluoride ions in the region of a component which is to be cleaned for the purpose of an intimate bringing into contact of the gaseous reaction agent with the walls of the cracks and cavities within the damaged component.

In DE 10 2005 051 310 A1, it is proposed to periodically purge the reaction chamber, in which a halogenous gas mixture is introduced for purposes of component cleaning, with a non-halogenous gas during the cleaning.

US 6,536,135 B2 describes a FIC process in which an improved oxide cleaning is undertaken by variation of the partial pressures of the cleaning gas mixture by carbon being added as an additional component to the cleaning gas mixture which consists of hydrogen fluoride (HF) and hydrogen (H_2). The carbon is added in the form of different compounds which form a carbonaceous gas during the process.

Furthermore, a typical cleaning retort, which provides a cylindrical housing which can be closed off from the top in a gastight manner and which in an opened state

can be loaded from the top with components which are to be cleaned, is to be gathered from the publication. The components which are to be cleaned are accommodated on racks, so-called trays, which are provided vertically one above the other and fastened on a central pipe which is arranged centrally in the cleaning retort and through which a carbon-enriched hydrogen fluoride-gas mixture is fed to the cleaning retort. The central pipe which penetrates the retort head in a gastight manner extends vertically inside the cleaning retort downwards into the region of the so-called retort sump in which the central pipe provides a gas distribution structure which extends essentially over the entire cross section of the cleaning retort, and with discharge openings via which the halogenous cleaning gas mixture is fed into the cleaning retort in a manner in which it rises from the bottom upwards. In doing so, the cleaning gas mixture flows through the entire retort volume from the retort sump in the direction of the retort head on which a corresponding gas outlet opening is provided.

The applicant furthermore has longstanding practical experience in the field of cleaning gas turbine components of the previously described type, which for operationally induced reasons are contaminated, corroded, oxidized and degraded, especially using FIC cleaning processes and also the cleaning plants which are required for it. In the longstanding association with a cleaning retort which relates to this, which via a central pipe is fed with a cleaning gas mixture which contains hydrogen fluoride and hydrogen in varying ratios, it has been shown that significant malfunctions in the cleaning process are created as a result of volume fluctuations in the feed of the cleaning gas into the cleaning retort, which, upon exceeding certain proportions, can occasionally lead to the breakdown of the entire cleaning process. More accurate

investigations furthermore showed that the feeding of fluctuating hydrogen fluoride gas volumes inside the cleaning retort lead to concentration fluctuations which ultimately result in a reduced cleaning efficiency and in an inaccurately controllable cleaning quality which is associated with it. In particular, in the case of very badly damaged components with a large number of material cracks which furthermore have a wide spectrum with regard to depth, width and length of the individual cracks, an intended level of cleaning under these circumstances can no longer be ensured. The consequences of an incomplete cleaning of components which are covered with a layer of complex oxides has already been referred to above.

A further disadvantageous and therefore improvement-deficient aspect in the case of the cleaning practices which have been used up to now relates to the construction of the cleaning retort. On the one hand, the inflow of cleaning gas into the cleaning retort by means of the centrally guided central pipe and by means of a distribution structure which is provided in the bottom sump region of the retort, and the positioning and stacking possibilities of the individual components which are to be cleaned on the stacking trays which are provided along the central pipe in a vertical sequence, have already been referred to in connection with the previously cited US 6,536,135 B2. On account of such a known construction, the stacking or positioning possibilities for the individual components which are to be cleaned in the cleaning retort are limited. The equally improvement-deficient ratios of flow onto the individual components which are to be cleaned inside the cleaning retort add to this, particularly as it cannot be ruled out that on account of a mutual masking of specific surface regions on the components which are to be cleaned only an inadequate impingement with cleaning gas is carried out. Thus, the fact that

regions with comparatively poor flow ratios and concentration ratios, up to the point of there being dead water regions, are formed as a result of a cleaning gas feed which is provided exclusively in the
5 retort sump region, as a result of which a smaller gas exchange is initiated, especially in regions of the cracks, is not to be ruled out.

For countering the previously pointed out problems with
10 regard to the improvement of cleaning quality, attempts to increase the cleaning cycle times in order to maintain a longer interaction period between the components which are to be cleaned and the cleaning gas mixture, produced only inconsequential results.
15 Moreover, cleaning processes with an increased HF concentration were carried out. However, these attempts only showed that the set cleaning aims were not focused to a satisfactory degree. Rather, these measures led to a cost increase and also to an
20 increased material attack on the components which are to be cleaned.

Summary of the invention

25 The invention is based on the object of developing a device for cleaning oxidized or corroded components, especially gas turbine components which are exposed to hot gases, in the presence of a halogenous gas, with a cleaning retort which as a rule is designed in the
30 shape of a boiler, into which indirectly or directly leads a feed line which via a flow control unit is connected to a reservoir which stores the halogenous gas, in such a way that on the one hand it is ensured that the problems which are associated with an
35 inadequate or fluctuating cleaning gas feed into the cleaning retort are completely remedied. On the other hand, it is necessary to take measures which ensure that each individual component which is to be cleaned

and to be introduced into the cleaning retort is exposed to a preferably direct onflow by the cleaning gas so that as far as possible no masking effects nor flow dead spaces can be formed within the gas flow. All the measures which are to be taken, moreover, are to be taken from the point of view of economical considerations and a cleaning of each individual component which is as careful as possible but effective.

According to an embodiment of the invention, there is provided a device for cleaning oxidized or corroded components, in the presence of a halogenous gas mixture, comprising a cleaning retort into which indirectly or directly leads a feed line which is connected via a flow control unit to a gas reservoir which stores the halogenous gas, wherein the flow control unit provides at least one gas volume control valve, a heat exchanger unit and also a gas volume measuring unit in sequence along the throughflow direction of the halogenous gas which flows through the feed line.

The device according to the solution is based on the knowledge that condensations, which especially occur in the region of throttling points, are formed along the feed line for feed of the halogenous gas. Such condensations lead to erroneous values within the scope of gas volume controlling and can lead right up to the total failure of the volume measuring. The halogenous gas is preferably stored in pressurized bottles. Under storage conditions it is in liquid form. By increasing the temperature the liquid is evaporated and the

temperature-dependent vapor pressure of the substance is established. Therefore overpressure conditions prevail upstream of the gas control unit. The pressure inside the cleaning retort lies typically at the pressure level of 50 torr to 780 torr. Therefore, at least one pressure reducing throttling stage is required along the feed line. With this, the previous condensation problem occurs. As a throttling point along the feed line the device according to the solution includes at least one flow control unit which provides a gas volume control valve which expands the gas. For countering the condensation which is formed in this case, a heating unit, which preferably has a gas heater, is provided in the flow direction, directly following the gas volume control valve, as a result of which the temperature level in this region of the line is raised above the condensation level of the halogenous gas, preferably of HF gas. The gas volume control unit is connected directly to the heat exchanger downstream along the feed line. By means of the measure according to the solution, the forming of HF condensate can be efficiently avoided. Erroneous measurements as well as a complete failure of the flow control unit can be completely excluded with this, as a result of which, moreover, the service life of the individual components of the flow control unit is also significantly increased. This in turn has a positive effect on the initial costs and operating costs and furthermore improves the availability of such cleaning plants.

Heating of the heat exchanger using extremely varied heating techniques is basically possible. The use of an electric heater has proved to be especially advantageous. Equally, however, it is also possible to indirectly heat the line section downstream of the gas volume control valve via correspondingly heated heat transfer media or other heat media. For the materials

which are used in the heat exchanger unit, which have contact with the halogenous gases, there is the requirement for chemical resistance to the aggressive halogenous gases, preferably to HF gas.

5

The heat exchanger unit, with regard to its heat yield, is designed or selected in such a way that a temperature level between 22° C and 75° C, preferably 40° C to 50° C, and especially preferably 44° C to 46° C,
10 can be established.

In an advantageous development, a shut-off valve is provided in each case in the feed line upstream and downstream to the flow control unit, and in the case of
15 a possible failure of the flow control unit can be operated automatically or manually in each case. In order to ensure that the cleaning gas inflow through the feed line itself is still ensured in such a case, a bypass line to the flow control unit is provided along
20 the feed line, and along which a control valve, preferably a hand control valve, is introduced.

Further details of a preferred embodiment are subsequently left to the description with reference to
25 the figures.

In order to ensure that the individual components which are to be cleaned inside the cleaning retort are optimally exposed to onflow by the cleaning gas in the interests of the cleaning process, according to an embodiment of the invention, there is
5 provided the device as described above, wherein a central pipe is provided, which is connected indirectly or directly to the at least one feed line, extends from the retort head to a retort sump inside the cleaning retort, and in the region of the retort sump is connected to a first distribution structure
10 which extends radially to the central pipe and has discharge openings for the halogenous gas mixture, wherein the first distribution structure provides a support surface for the components which are to be cleaned, wherein a second distribution structure is provided, which is arranged on the
15 central pipe at a distance from the first distribution structure and provides a support surface, which extends radially to the central pipe, for the components which are to be cleaned, and wherein the distribution structures have discharge openings for the halogenous gas, which are oriented
20 at least in the direction of, and facing, the components which lie upon them.

The new-type gas distribution concept provides the arrangement of preferably a plurality of so-called distribution structures which are arranged one above the other along the central pipe and which are attached on the central pipe either in a self-supporting manner or are combined with suitably designed support structures along the central pipe.

In variance to the previous cleaning gas feed, which is carried out directly from the central pipe radially outwards, or, according to US 6536135 B2, in the region of the retort sump, the newly conceived gas distribution provides in each case individual gas feeds along the central pipe in the respective regions of the support surfaces in each case upon which lie the individual components which are to be cleaned. In this way, the new-type decentralized gas distribution in the cleaning retort serves for distributing the process gas as optimally as possible by the cleaning gas being fed to, and guided away from again, each individual component under largely identical conditions. On account of an individual cleaning gas feed in each individual support surface for the components which are to be cleaned it is ensured that each individual component is exposed directly and in a suitable manner

to impingement by cleaning gas. The number and also the arrangement of the discharge openings which are provided in the respective distribution structure, can be basically optionally selected, but preferably taking into consideration shape, size and arrangement of the components which are to be cleaned.

The distribution structures which are attached in each case along the central pipe with axial spacing and which depending upon design can be integrated into stable support structures or can be designed in the form of inherently stable plate or tube constructions, are produced from a material which is resistant to the process conditions which prevail in the cleaning retort, IN600 (Inconel 600) preferably being offered for this.

Depending upon the cleaning task and also upon the size and number of the components which are to be cleaned, the cleaning retort is to be equipped with a suitable number of distribution structures which are to be arranged in a distributed manner along the central pipe and upon which the components which are to be cleaned are to be placed.

In a preferred embodiment, the individual distribution structures can be introduced in a modular-like manner and taking into consideration the previously described cleaning task. For this purpose, the distribution structures have a central collar with a collar opening for accommodating the central pipe. By means of the collar, the individual distribution structures can be positioned and fixed along the central pipe. In order to suitably select the distance between two distribution structures which are to be attached along the central pipe, a corresponding number of cylindrical distance sleeves are to be provided, which as spacers are moved along over the central pipe and which with

the collars which are provided with the distribution structures are fixed along the central pipe at a distance from each other.

5 The distribution structures which extend in each case radially from the collar can basically be designed or constructed in different ways. Plate-form or grid-form, or tubular designs for the distribution structure have proved to be especially advantageous. In the case 10 of the design of a distribution structure which is assembled from individual pipe sections or pipes, at least one branch line which extends radially from the central pipe is provided, upon which at least one circular pipe, which is radially at a distance from the 15 central pipe, is attached in a manner in which it annularly encompasses the central pipe. The respective discharge openings are applied along the at least one branch pipe and also along the at least one circular pipe and preferably oriented upwards in each case so 20 that the components which lie upon the distribution structure are directly exposed to impingement by the cleaning gas which issues from the discharge openings. For supplying the distribution structures with the cleaning gas, the previously described collars, to 25 which the distribution structure is connected, have gas openings which are oriented radially to the central pipe and through which the cleaning gas which radially discharges from the central pipe via corresponding gas discharge openings can reach the respective 30 distribution structures. Details of this can be gathered from the further description with reference to the figures.

In a further embodiment, the respective distribution 35 structures are designed like disks and in each case have an upper and lower disk plate which include an interspace which, moreover, is enclosed in a gastight manner by a disk rim which connects the two disk plates

on their circumferential edge in a fluidtight manner. The disk volume which is delimited in this way is fed via an opening which faces the central pipe with the halogenous cleaning gas which can escape from the disk volume at least via discharge openings which are introduced in the upper disk plate. The number, arrangement or alignment, and also the diameter, of the individual discharge openings can basically be variably adjusted within broad ranges. Thus, per distribution structure for example between 100 and 10000 holes or discharge openings, each with diameters between 0.1 mm and 5 mm, are provided.

Depending upon dimensioning of the cleaning retort, and also dimensioning of the components which are to be cleaned inside the cleaning retort, preferred dimensions for the discharge openings have been proved in practice, which per distribution structure provide 1000 to 5000 discharge openings each with diameters between 0.5 mm and 2.5 mm.

For purposes of an improved onflow with cleaning gas which is adapted to the shape and size of the components which are to be cleaned in each case, it is necessary to suitably arrange or to distribute the discharge openings with regard to the usually circular support surface in sectors, for example in the form of radially extending lines or radially and circumferentially arranged field patterns in which the discharge openings are arranged in clusters.

In addition to the design of the discharge openings in the form of conventional holes, it is especially advantageous to configure the discharge openings like nozzles so that the individual gas flows which issue from the discharge openings impinge upon the component which is to be cleaned in each case with an optimized flow velocity and also with a predeterminable outflow

direction. Flow guiding elements which influence the gas discharge direction per discharge opening serve for this in an especially advantageous way and can already be formed in a suitable manner during the production of
5 the discharge openings, for example within the scope of shape-forming stamping processes.

In a further preferred embodiment variant, the distribution structures provide not only discharge
10 openings for the cleaning gas on the upper side which faces the support surface in order to expose the components which are lying on the respective distribution structures to impingement with cleaning gas, but furthermore corresponding discharge openings
15 are also provided on the opposite underside in order to direct some of the cleaning gas which issues via the distribution structure to those components which lie upon the support surface which is located directly beneath it.
20

Despite the large number of possible design variants for a respective distribution structure, it can still happen in the case of individual components which are to be cleaned that these are not optimally exposed to
25 impingement by the cleaning gas. In order to eliminate this disadvantage, it is expedient to provide additional cover plates, deflection plates or guard plates, the task of which is to correspondingly deflect gas flows inside the cleaning retort. Such optional
30 additional components, which are also referred to as gas guide plates, can preferably be attached between the respective distribution structures, or directly on the components which are to be cleaned, in order expose specific areas of components to impingement by the
35 cleaning gas in a particular way, or else to screen specific areas against the cleaning gas in order to avoid a direct contact with the cleaning gas.

Ways of implementing the invention

The invention is exemplarily described in the following without limitation of the general inventive idea, based on exemplary embodiments with reference to the drawing. In the drawing:

Fig. 1 shows a schematic view of the construction of a cleaning retort which is designed according to the solution,

Fig. 2 shows a perspective view of a distribution structure,

Fig. 3 shows a distribution structure with a plate-form design,

Fig. 4 shows a partially sectioned view of a distribution structure which is designed in plate form,

Fig. 5 shows a distribution structure with discharge openings which are arranged in a segmented manner, and also

Fig. 6 shows an illustration of discharge openings with flow elements.

Ways of implementing the invention, industrial applicability

Figure 1 illustrates a schematic construction of a cleaning retort (right-hand half of figure), which is supplied with a cleaning gas mixture via a cleaning gas piping system (left-hand half of figure). The cleaning retort has a retort housing 11 which is designed essentially in the shape of a cylinder or barrel and

which on its upper side is closed off in a gastight manner with a retort cover 14. The retort housing 11 is enclosed by a heating jacket 12 in which heating devices 13 ensure a cleaning process temperature in the
5 interior of the cleaning retort of up to 1200^{0} C. A central pipe 23 is provided centrally inside the cleaning retort and outwardly penetrates the retort cover 14 in a gastight manner, and into which cleaning gas is fed via a feed line 10. Moreover, a retort
10 outlet 24 is provided inside the cleaning retort, via which used cleaning gas is carried out via a corresponding exhaust gas pipe 25 for further supply or disposal.

15 For the provision of cleaning gas, two gas reservoirs 1, 1', specifically a gas reservoir for providing hydrogen fluoride (HF) and a gas reservoir for providing hydrogen gas (H_2), are provided in the exemplary embodiment which is shown in Figure 1. It is
20 necessary to mix the two sorts of gas in a suitable manner with a predetermined mixing ratio before feeding into the feed line 10. For this purpose, a flow control unit is connected along a feed line directly downstream of the HF gas reservoir 1 and comprises a
25 gas volume control valve 5, a heat exchanger unit 9 preferably in the form of a gas heater, and also a gas volume measuring unit 6. The heat exchanger unit 9, which is connected directly downstream to the gas volume control valve 5, provides for a marked
30 temperature increase beyond the condensation temperature of the HF gas so that a HF gas supply which is not impaired by any condensation processes can be ensured by means of the flow control unit. A gas temperature control loop 8 serves for the monitoring
35 and controlling of the heat exchanger unit 9. A suitable gas volume control loop 7 is provided for the controlled implementation of the gas volume measuring.

In order to avoid a process breakdown which is associated with the occurrence of a possible failure of the automatic control with regard to the gas temperature and/or to the gas volume, a bypass line 2 is additionally provided, in which a shut-off valve, preferably a hand control valve 4, is mounted. The bypass line 2 is used in that case during which the flow control unit, which comprises the gas volume control valve 5, the heat exchanger unit 9 and the gas volume measuring unit 6, is isolated from the gas feed upstream and downstream by means of two block valves 3. The installed block valves 3 can preferably be designed in the form of valves, cocks or gates which can be operated both by hand and automatically.

The hand control valve which is provided in the bypass line 2 is preferably designed as a needle-type throughway valve which enables a very finely metered adjustment of the HF gas flow.

The HF cleaning gas mixture which is fed along the feed line 10 into the central pipe 23 discharges inside the process chamber 16 of the cleaning retort via distribution structures 20 which are attached in different planes along the central pipe 23 and upon which lie the components 26 which are to be cleaned in each case. In the exemplary embodiment which is shown, the distribution structures 20 which are provided in the process chamber 16 are constructed separately to support structures 19 which likewise are attached radially on the central pipe 23 and upon which the distribution structures 20 are supported. Via the central pipe 23, the cleaning gas reaches the distribution structures 20 in each case, from which it discharges in a directed manner directly onto the components 26 which are to be cleaned. Additional gas guide plates 27, 28 and 29, which are provided inside the process chamber 16, ensure exposure of the

individual components 26 which are to be cleaned to an individual onflow with cleaning gas.
The lowermost distribution structure 20, which is integrated into a stable tray support 21 which is
5 preferably connected to the central pipe 23 in a fixed manner, is located in the region of the retort sump 17.

In order to protect the region of the retort head 15, especially the retort cover 14, against an excessively
10 intense heat loading, a heat shield 22 is attached on the central pipe 23 in the upper region inside the cleaning retort.

In Figure 2, a preferred embodiment of a distribution
15 structure 20 is shown in perspective view. The distribution structure 20 has a center collar 43 which can be slid in a force-guided manner over the central pipe, which is not additionally shown. If only for completeness it should be pointed out that instead of
20 the collar the distribution structure 20 can also be connected directly to the central pipe 23, wherein in this case the component 43 corresponds to the central pipe.

25 Four branch pipes 40 which extend radially from the collar 43 are connected to this, and concentric circular pipes 41 are connected in each case to the branch pipes. The branch pipes 40 and also the circular pipes 41 form an intercommunicating piping
30 system which is supplied with cleaning gas from the central pipe 23, which is not shown. For this purpose, the collar 43 has openings (not shown) via which the cleaning gas which is provided from the central pipe 23 can be fed into the distribution system. In the
35 exemplary embodiment which is shown, the distribution structure 20 is designed in an inherently stable and robust manner, and is connected rigidly enough to the collar 43 to absorb both the dead weight of the

distribution structure 20 as well as the weight of the components 26 which are to be cleaned which are to be placed on the distribution structure 20.
The discharge openings which are provided along the
5 branch pipes 40 and also along the circular pipes 41 and via which the cleaning gas discharges in the direction of the components which lie upon the distribution structure 20, are not shown in Figure 2.

10 Figure 3 illustrates in a much schematized manner an alternative exemplary embodiment for a distribution structure which is designed in plate form. The distribution structure in this case has an upper 50 and a lower 51 disk plate, the two plates 50 and 51 being
15 delimited by an encompassing disk rim 52 and including an inner volume. In addition, the distribution structure is connected to a mechanically stable support structure 54. The upper disk plate 50 has sectors which are characterized by boundary lines 55 which in
20 the case which is shown extend radially in each case. The individual sectors can be exchanged in order to adapt the retort as variably as possible to different component types. In the middle, the distribution structure, which is designed in plate form, is
25 penetrated by the central pipe 23 upon which the distribution structure 20 is attached in a fixed manner. Alternatively, the distribution structure is connected to a previously described collar which is threaded over the central pipe 23.
30
In Figure 4, a perspective cross-sectional view through a distribution structure which is designed in plate form is shown. In this case, it may be assumed that the upper and the lower disk plates 50, 51 are attached
35 directly on the center central pipe 23. 23 can also be a collar. Via corresponding connecting openings 55, cleaning gas which is fed through the central pipe or collar 23 reaches the interspace between the upper and

lower disk plates 50, 51. Via corresponding discharge openings 56 which are incorporated in the upper disk plate 50, the cleaning gas finally discharges into the process chamber. The discharge openings 56 are
5 correspondingly arranged, preferably taking into consideration the components which are to be cleaned which are to be placed on the upper disk plate 50. The exemplary embodiment which is shown in Figure 4 provides field-like arrangement patterns in sectors for
10 the discharge openings 56. In Figure 5, the plan view of a segment surface of the upper disk plate 50 is shown, in which a multiplicity of fields 57 are arranged and which in each case consist of a multiplicity of individual discharge openings 56. The
15 arrangement and also the number of discharge openings 56 within the individual fields 57 can be selected identically or differently in each case, preferably in dependence upon the components which are to be cleaned in each case.

20

Figure 6 shows in a schematized manner an enlarged view of a field 57 in which a multiplicity of individual discharge openings 56 are provided. The contours of the individual discharge openings are evident with
25 reference to the sectional views A-A and also B-B. In particular, it can be gathered from the sectional view A-A that each individual discharge opening 56 is covered by a flow guiding element 58, as a result of which the discharge flow can impinge upon the
30 respective component in a spatially directed manner.

A number of advantages with regard to the cleaning of especially gas turbine components which are exposed to impingement by hot gas are associated with the
35 previously described measures with regard to an optimized gas volume control and also to an optimized gas distribution. Thus, on account of the optimized gas volume control a constant gas volumetric flow is

formed which can be fed with a small fluctuation range into the cleaning retort. The gas distribution inside the cleaning retort is significantly more homogeneous and more uniform. The individual components can be exposed better and in a defined manner to onflow by the cleaning gas so that a uniform onflow in all surface areas on the components which are to be cleaned can be achieved. In particular, as a result of the measures which are taken no dead spaces occur in which the components which are to be cleaned are more poorly exposed, or not exposed at all, to circumflow or onflow. By means of the cleaning concept according to the invention a significantly better depth-cleaning, i.e. better oxide removal, of cracks can especially be achieved.

Moreover, the optimized control and gas distribution helps to significantly reduce the volume of HF gas which is to be fed for cleaning purposes. This reduces for one thing the risk of damage to individual components with simultaneously improved cleaning action. For another thing, as a result of this overetched surface areas on the components can be safely avoided. Furthermore, the entire plant is less loaded by the chemically highly-reactive cleaning gas so that the service and operating lives of such plants and their components can be significantly prolonged. In all, the measures according to the invention help to significantly reduce resources such as the process gases, power and, furthermore, necessary operating means. Thus, the reduction of cleaning gas automatically leads to the reduction of possible discharge substance flows which are to be disposed off, and therefore to the significant reduction of waste. In all, the operating costs of such plants can be noticeably reduced with the concept according to the solution. A higher loading density of the retort, and

also a reduction of the process times, also contribute to this.

List of designations

	1	Gas reservoir
	2	Bypass line
5	3	Block valve
	4	Hand control line
	5	Gas volume control valve
	6	Gas volume measuring unit
	7	Control loop for gas volume
10	8	Control loop for gas temperature
	9	Heat exchanger unit
	10	Feed line
	11	Cleaning retort
	12	Heating unit
15	13	Heaters
	14	Retort cover
	15	Retort head
	16	Process chamber
	17	Retort sump
20	18	Retort tray
	19	Support structure
	20	Distribution structure
	21	Support structure-tray support
	22	Heat shield
25	23	Central pipe
	24	Retort outlet
	25	Exhaust gas pipe
	26	Component
	27, 28	Gas guiding plates
30	29	
	40	Branch pipe
	41	Circular pipe
	42	Junction points
	43	Collar
35	50	Upper disk plate
	51	Lower disk plate
	53	Disk frame
	54	Support structure

55 Connecting opening
56 Discharge openings
57 Field of discharge openings 56
58 Flow guiding element
5 59 Sector plate

CLAIMS:

1. A device for cleaning oxidized or corroded components, in the presence of a halogenous gas mixture, comprising a cleaning retort into which indirectly or directly
5 leads a feed line which is connected via a flow control unit to a gas reservoir which stores the halogenous gas,

wherein the flow control unit provides at least one gas volume control valve, a heat exchanger unit and also a gas volume measuring unit in sequence along the throughflow
10 direction of the halogenous gas which flows through the feed line.

2. The device as claimed in claim 1,

wherein a shut-off valve is provided in the feed line upstream and downstream to the flow control unit, and

15 wherein a bypass line to the flow control unit is provided along the feed line, along which bypass line a control valve is introduced.

3. The device as claimed in claim 2,

wherein the shut-off valves are designed as a block
20 valve.

4. The device as claimed in either of claims 2 or 3,

wherein the control valve is designed as a hand control valve.

5. The device as claimed in any one of claims 1 to 4,

wherein the heat exchanger unit has an electric heater.

6. The device as claimed in any one of claims 1 to 5,

wherein the halogenous gas is hydrogen fluoride gas.

5 7. The device as claimed in any one of claims 1 to 6,

wherein the feed line, before entry into the cleaning retort, leads into an inlet line which leads into the cleaning retort, into which inlet line at least one second feed line leads before entry into the cleaning retort.

10 8. The device as claimed in claim 7,

wherein the second feed line is connected to a hydrogen gas reservoir.

9. The device as claimed in any one of claims 1 to 8,

wherein a central pipe is provided, which is
15 connected indirectly or directly to the at least one feed line, extends from the retort head to a retort sump inside the cleaning retort, and in the region of the retort sump is connected to a first distribution structure which extends radially to the central pipe and has discharge openings for the
20 halogenous gas mixture,

wherein the first distribution structure provides a support surface for the components which are to be cleaned,

wherein a second distribution structure is provided, which is arranged on the central pipe at a distance from the

first distribution structure and provides a support surface, which extends radially to the central pipe, for the components which are to be cleaned, and

wherein the distribution structures have discharge
5 openings for the halogenous gas, which are oriented at least in the direction of, and facing, the components which lie upon them.

10. The device as claimed in claim 9,

wherein additional distribution structures are
10 arranged along the central pipe at a distance from each other.

11. The device as claimed in claim 10,

wherein the second and the additional distribution structures have discharge openings for the halogenous gas which are directed onto the distribution structure which is directly
15 adjacent along the central pipe.

12. The device as claimed in any one of claims 9 to 11,

wherein the first distribution structure and also additional distribution structures are designed in plate form or grid form.

20 13. The device as claimed in any one of claims 9 to 11,

wherein the distribution structure has at least one branch pipe which extends radially from the central pipe and from which projects at least one circular pipe which is radially at a distance from the central pipe and annularly
25 encompasses the said central pipe, and

wherein the discharge openings are applied along the at least one branch pipe and also along the at least one annular circular pipe.

14. The device as claimed in claim 13,

5 wherein the branch pipes and circular pipes are manufactured from a dimensionally stable tubular material, and

wherein the branch pipes and circular pipes describe a spider's web-like support surface upon which the components which are to be cleaned can be directly placed.

10 15. The device as claimed in any one of claims 9 to 11,

wherein the distribution structure encompasses the central pipe like a disk and by an upper and lower disk plate, and also a disk rim which connects the two disk plates in a fluidtight manner on their peripheral edge, include a disk

15 volume,

wherein the disk volume can be fed with the halogenous gas via at least one opening, which faces the central pipe, in the distribution structure, and

wherein at least the upper disk plate has discharge

20 openings for the halogenous gas.

16. The device as claimed in claim 15,

wherein flow guiding elements which influence the gas discharge direction are provided in each case at the discharge openings.

17. The device as claimed in claim 16,

wherein the upper disk plate provides recesses into which sector plates, which are designed like modules, can be inserted, and

5 wherein the sector plates individually provide predeterminable patterns at the discharge openings.

18. The device as claimed in any one of claims 9 to 17,

wherein the distribution structure is connected to a radially inner collar which serves as a bearing and support
10 structure, and

wherein the collar has an opening for accommodating the central pipe, along which the collar can be fixed in a force-guided manner.

19. The device as claimed in claim 18,

15 wherein a number of cylindrical distance sleeves are provided along the central pipe for purposes of a mutual spacing of two distribution structures along the central pipe.

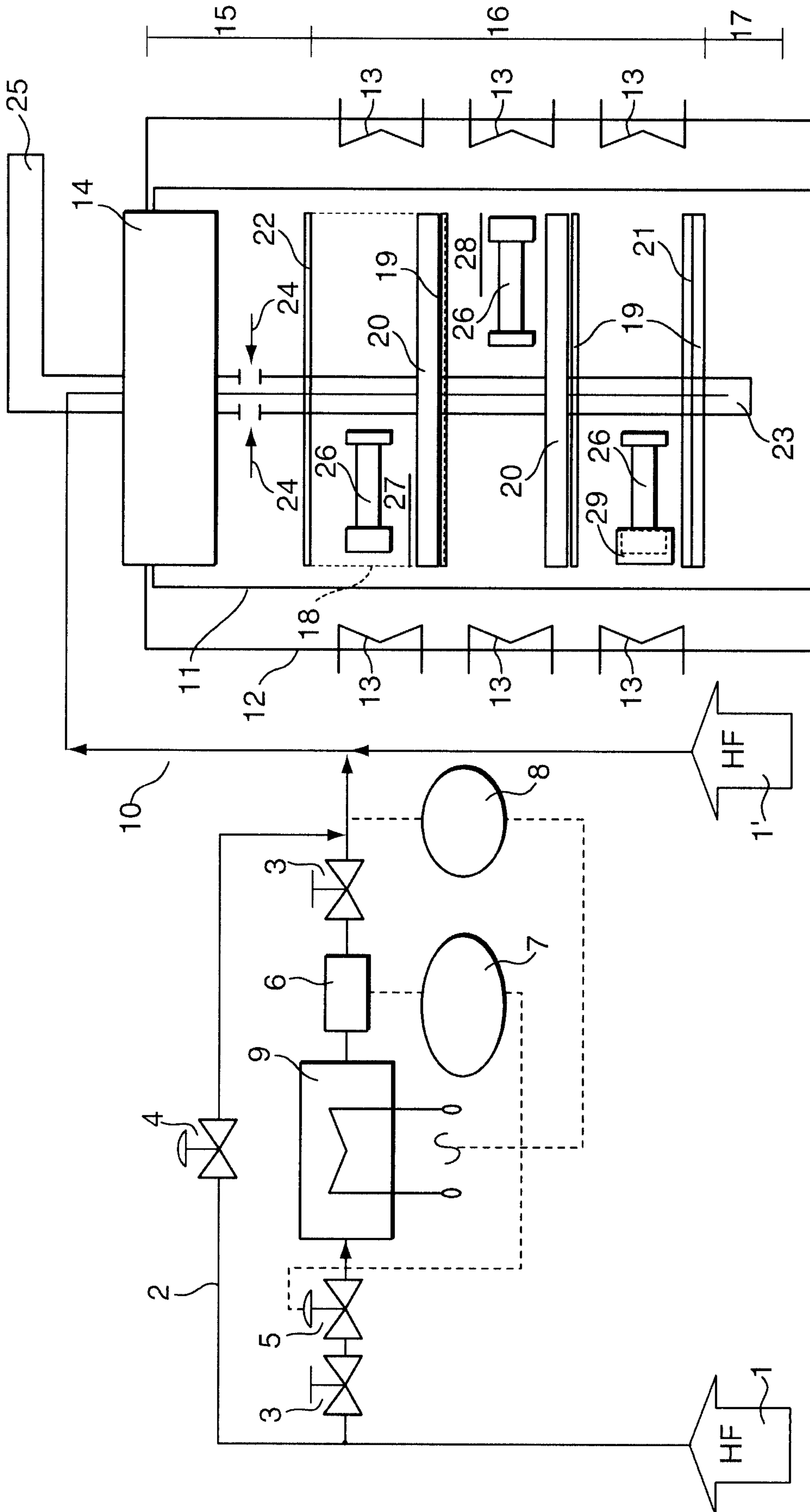


Fig. 1

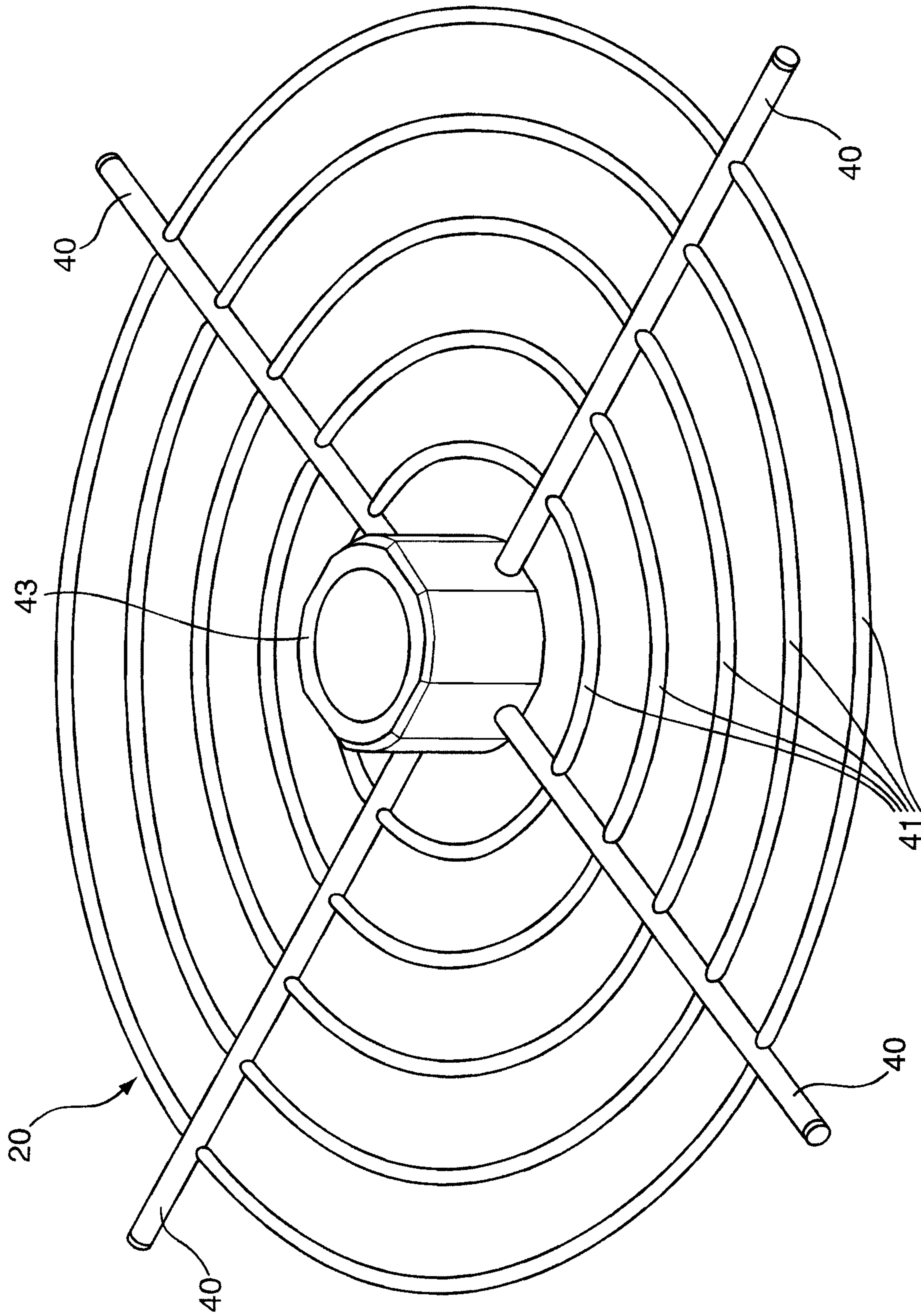


Fig.2

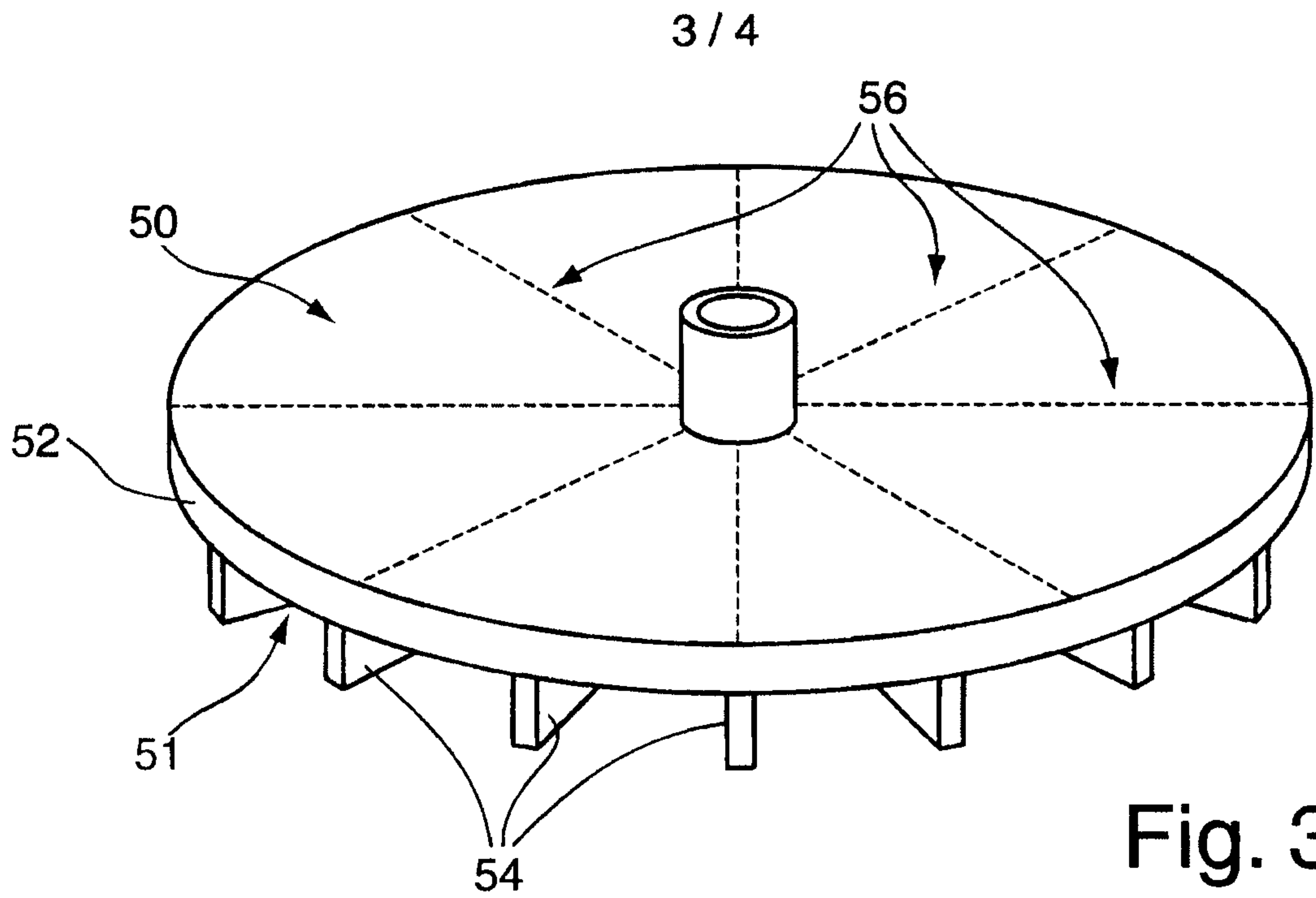


Fig. 3

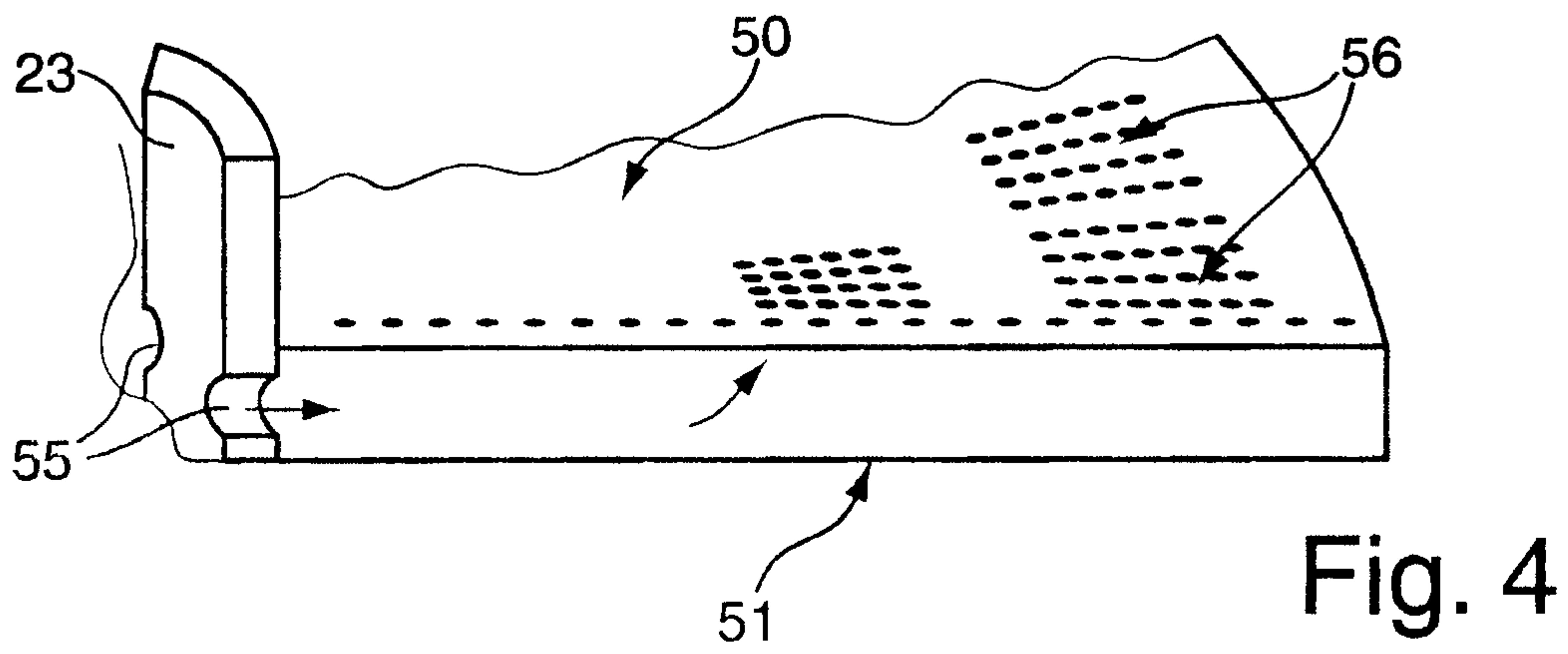


Fig. 4

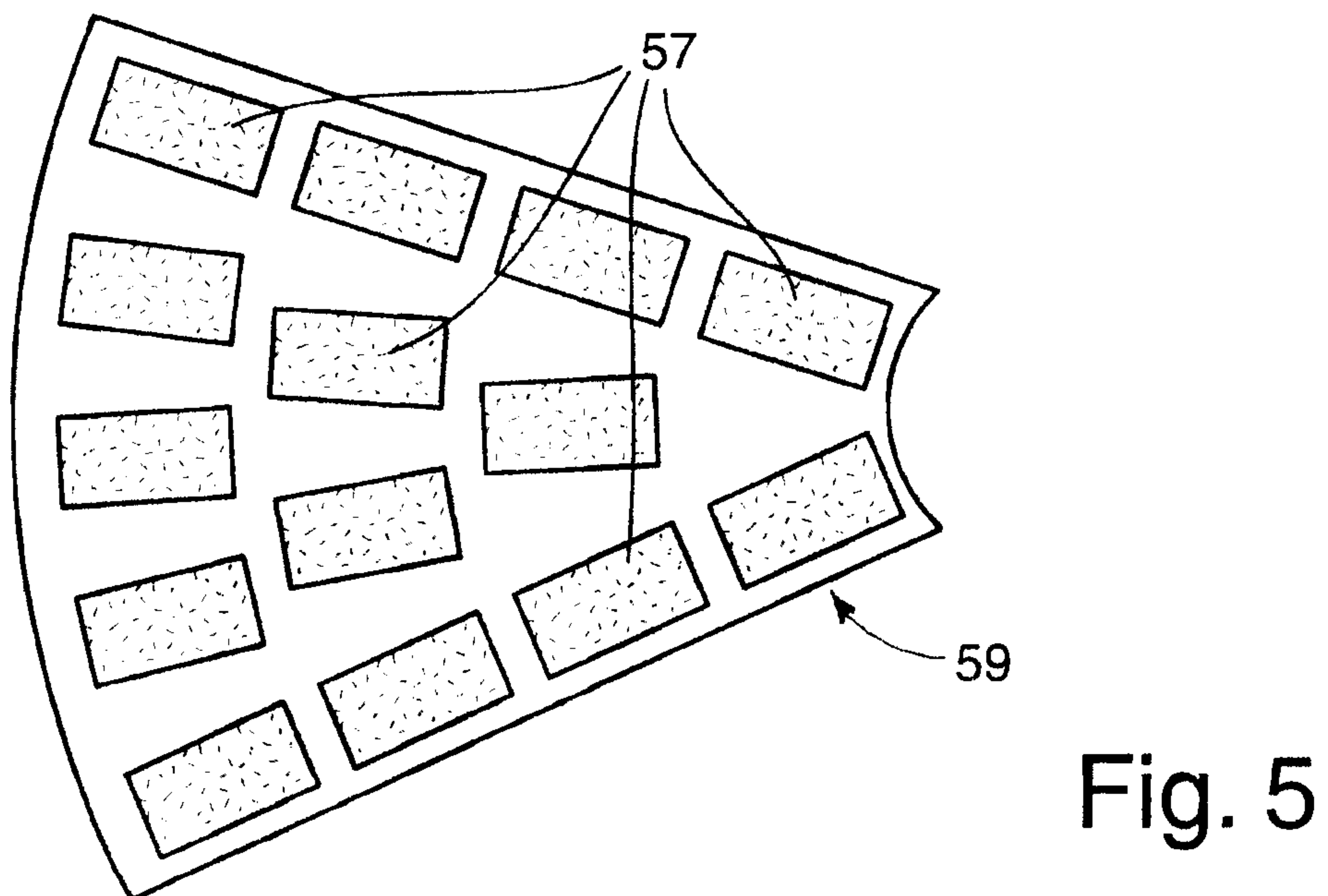
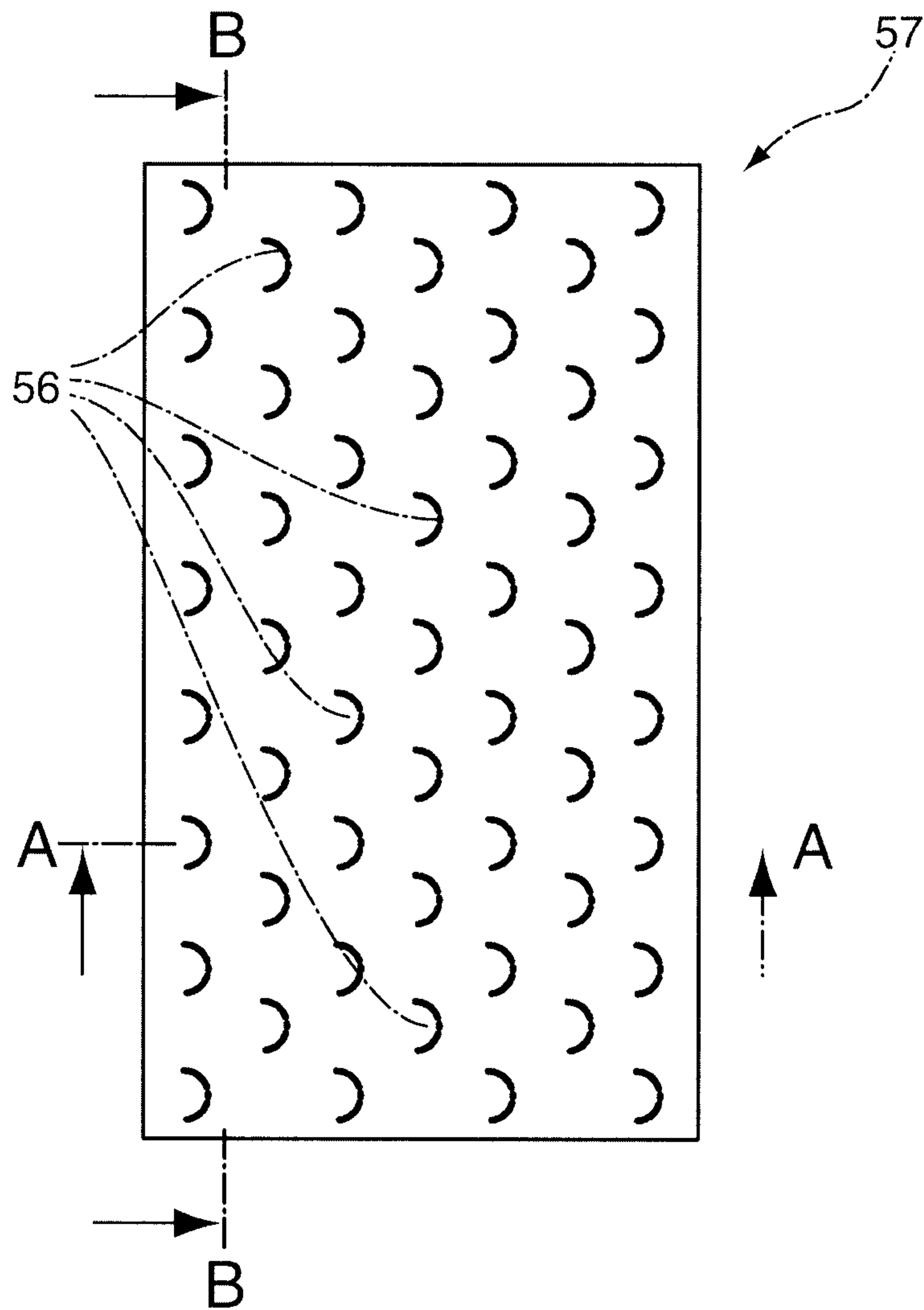
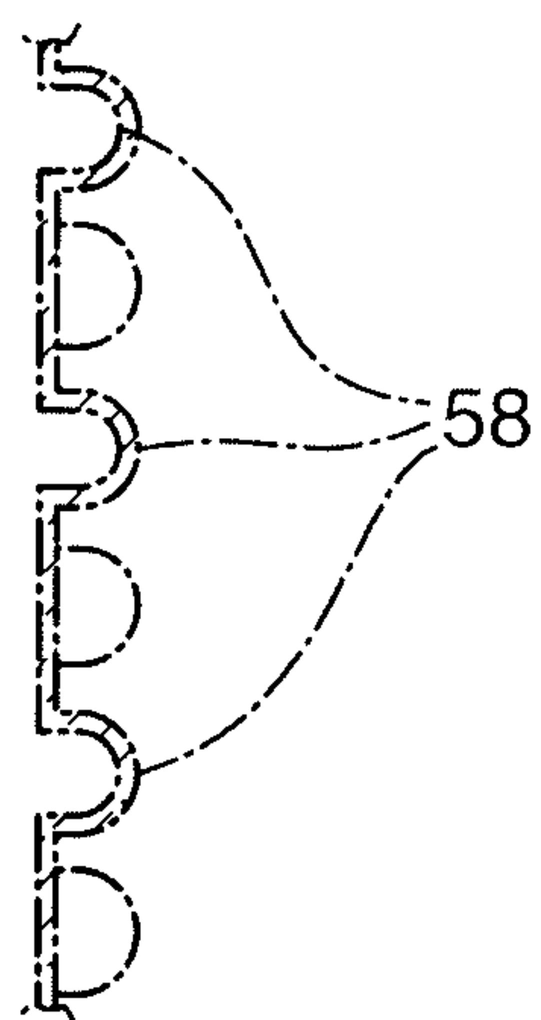


Fig. 5





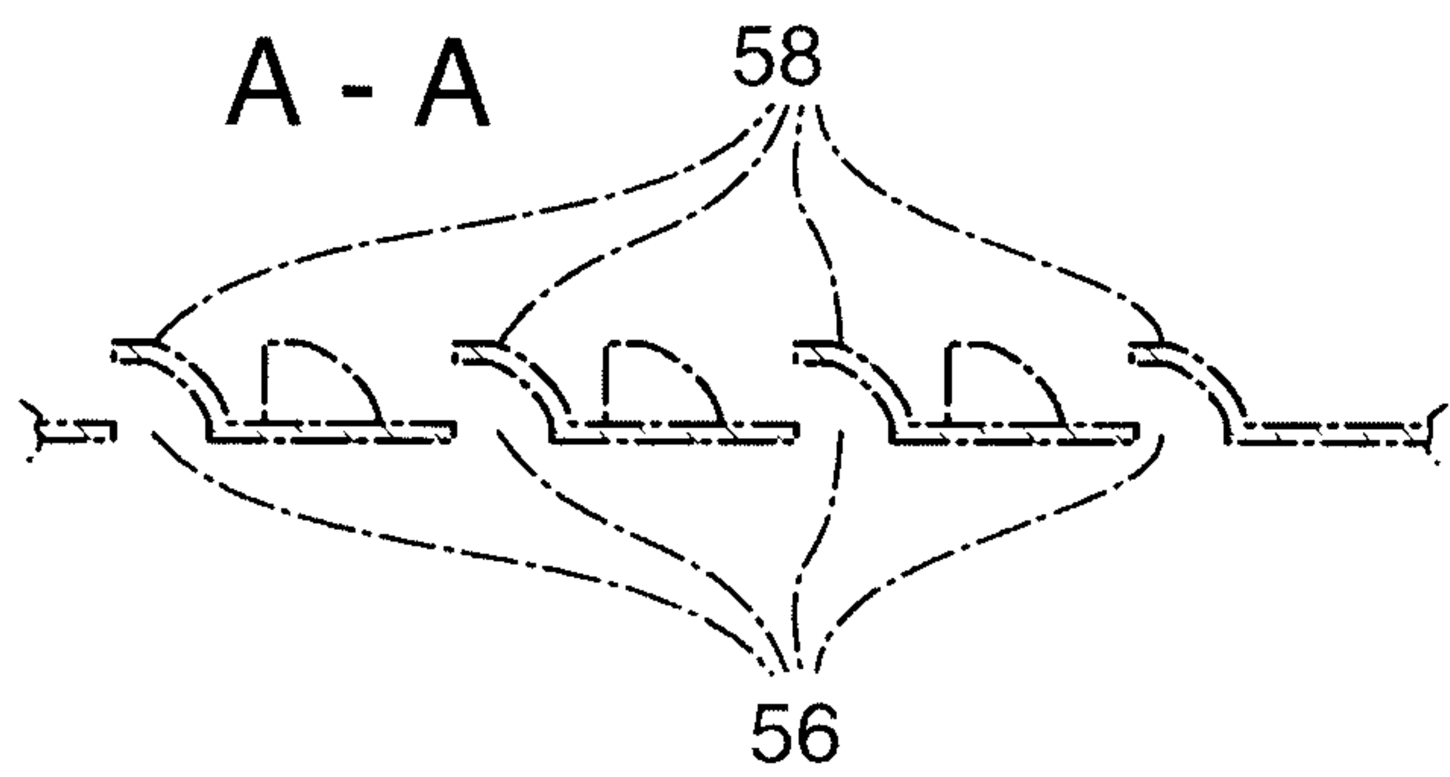
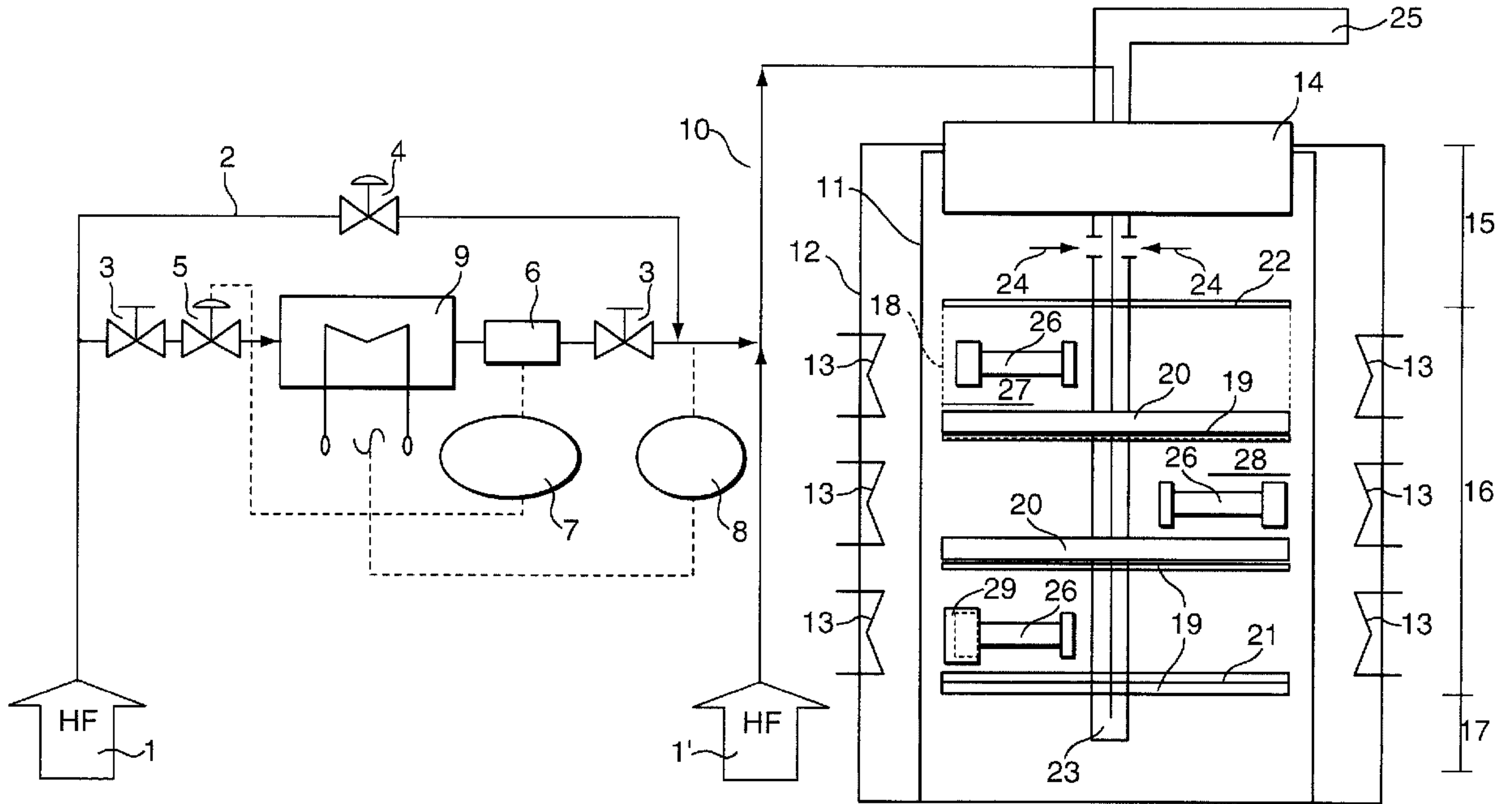


Fig. 6



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